CUI DEVICES

06/24/2021

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MODEL: HSB19-272718 | DESCRIPTION: HEAT SINK

FEATURES

- BGA design
- top mount
- aluminum alloy
- black anodized finish





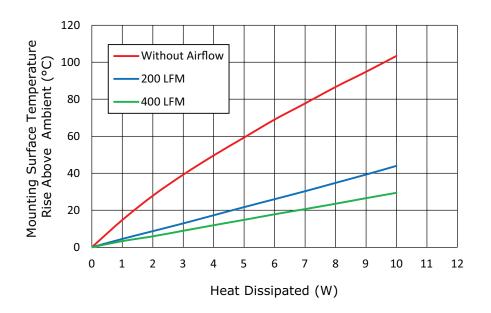
thermal resistance¹ power dissipation¹ @ 1 W, 400 LFM @ 75°C ∆T, @ 75°C ∆T, @ 1 W, @ 1 W, 200 LFM nat conv nat conv nat conv (°C/W) (°C/W) (°C/W) (°C/W) (W) HSB19-272718 14.7 4.5 3.3 6.75 11.11

1. See performance curves for full thermal resistance details.

PERFORMANCE CURVES

Heatsink Temperature Rise Above Ambient ($\Delta T = Ths - Ta$) (°C)		
Natural Conv.	200 LFM	400 LFM
0	0	0
14.7	4.5	3.3
27.8	8.7	5.9
39.2	12.9	8.9
49.6	17.3	11.9
59.3	21.7	14.8
69.0	26.0	17.8
77.7	30.3	20.6
86.6	34.8	23.5
94.8	39.3	26.5
103.4	44.0	29.4
	Natural Conv. 0 14.7 27.8 39.2 49.6 59.3 69.0 77.7 86.6 94.8	Natural Conv. 200 LFM 0 0 14.7 4.5 27.8 8.7 39.2 12.9 49.6 17.3 59.3 21.7 69.0 26.0 77.7 30.3 86.6 34.8 94.8 39.3

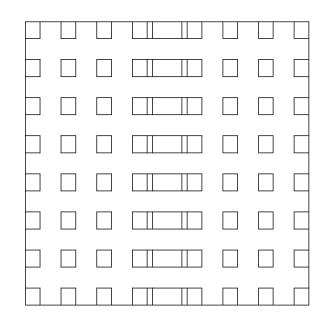
Ths: "hot spot" temperature measured on the heatsink Ta: ambient temperature

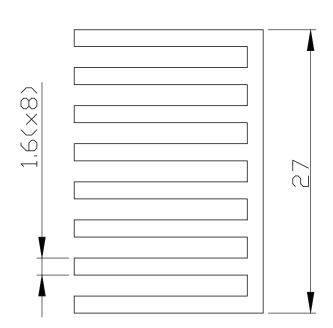


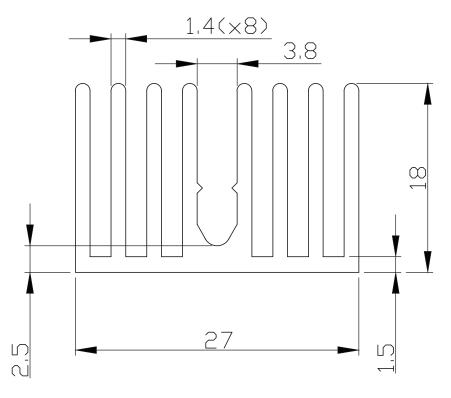
MECHANICAL DRAWING

units: mm tolerance: ±0.38 mm

AL 6063-T5
black anodized
9.1 g







Additional Resources: Product Page | 3D Model

CUI Devices | MODEL: HSB19-272718 | DESCRIPTION: HEAT SINK date 06/24/2021 | page 3 of 3

REVISION HISTORY

rev.	description	date
1.0	initial release	06/24/2021

The revision history provided is for informational purposes only and is believed to be accurate.

CUI DEVICES

CUI Devices offers a one (1) year limited warranty. Complete warranty information is listed on our website.

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